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Tungsten disulfide thin films *via* electrodeposition from a single source precursor†

 Shibin Thomas,^a Victoria K. Greenacre,^{*a} Danielle E. Smith,^a Yasir J. Noori,^b Nema M. Abdelazim,^b Andrew L. Hector,^a C. H. (Kees) de Groot,^b William Levason,^a Philip N. Bartlett^a and Gillian Reid^{*a}

We report a simple process for the electrodeposition of tungsten disulfide thin films from a CH₂Cl₂-based electrolyte using a tailored single source precursor, [NEt₄]₂[WS₂Cl₄]. This new precursor incorporates the 1:2 W:S ratio required for formation of WS₂, and eliminates the need for an additional proton source in the electrolyte to remove excess sulfide. The electrochemical behaviour of [NEt₄]₂[WS₂Cl₄] is studied by cyclic voltammetry and electrochemical quartz crystal microbalance techniques, and the WS₂ thin films are grown by potentiostatic electrodeposition.

Transition metal dichalcogenides (TMDCs) are an intriguing class of semiconducting materials due to their unique electronic and optical properties and tuneable band gaps, making them highly attractive candidates for nano- and atomic-scale devices. Structurally, they are layered materials with strong covalent bonds within the layers and weak van der Waals interactions between the layers. This weak interlayer bonding in TMDCs facilitates the fabrication of ultra-thin 2D single- and few-layer materials, the properties of which are distinctly different from their bulk phase, for example, exhibiting direct rather than indirect band gaps and with high carrier mobilities.²

Realisation of the potential of few-layer TMDCs in next generation devices requires scalable methods to deposit and pattern the materials. Techniques including physical and chemical vapour deposition,^{3,4} atomic layer deposition,⁵ and pulsed laser deposition⁶ are options, however, they each have their disadvantages.

Electrodeposition is an alternative deposition technique that is easily scalable, is typically performed at or near room

temperature and can be readily localised and controlled, making it very attractive for fabricating complex nanoscale features in low dimensional devices. Electrodeposition has been demonstrated for aqueous deposition of a small number of TMDCs, primarily MoS₂, and mainly for electrocatalytic applications where rough, irregular morphologies are favoured.⁷ Even though the hydrogen evolution in aqueous electrolytes is advantageous in some cases, such as in nanostructuring of metal deposits,⁸ it restricts the potential window and limits the range of different TMDCs that are accessible by this method. Consequently, non-aqueous electrolytes are of interest for the controlled growth of these materials and there have been a few reported studies on the non-aqueous electrodeposition of MoS₂.^{9–12} However studies of the electrodeposition of WS₂, an equally important 2D material, are very limited.^{13–17}

Possible single source precursors for MoS₂ or WS₂ electrodeposition are the [MS₄]²⁻ dianions, but the problem here is in getting rid of the excess S. For the electrodeposition of MoS₂ from non-aqueous solution this can be achieved by the addition of a proton source,⁹ but this reduces considerably the faradaic efficiency of the deposition, complicates the process and was not successful for the production of WS₂ from [WS₄]²⁻. Although electrochemical reduction of [NH₄]₂[WS₄] in MeCN with added LiClO₄ has successfully deposited films, the as-deposited films were S-rich (corresponding to WS_{2.8}) and a two stage crystallisation and sulfurisation process was necessary to obtain WS₂.¹⁵ Our attempts to perform similar electrochemistry in CH₂Cl₂ using [N^{*n*}Bu₄]₂[WS₄] were not successful (see ESI†).

In this paper we describe a new, more efficient and controllable approach using the tungsten(vi) tetrachloridedisulfide dianion, [WS₂Cl₄]²⁻, specifically designed to overcome this problem, while providing the required 1:2 tungsten:sulfur ratio in order to eliminate the requirements for a proton source.

The single source precursor, [WS₂Cl₄]²⁻, was synthesised as the [NR₄]⁺ (R = Et or ^{*n*}Bu) and [PPh₄]⁺ salts. The anion has been reported previously in [PPh₄]₂[WS₂Cl₄], made by reaction of WS₂Cl₂ and [PPh₄]Cl in a 1:2 molar ratio in CH₂Cl₂.¹⁸

^a School of Chemistry, University of Southampton, Southampton SO17 1BJ, UK.
 E-mail: shibin.thomas@soton.ac.uk, v.k.greenacre@soton.ac.uk,
 g.reid@soton.ac.uk

^b School of Electronics and Computer Science, University of Southampton,
 Southampton SO17 1BJ, UK

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We obtained $[\text{PPh}_4]_2[\text{WS}_2\text{Cl}_4]$ as a dark brown powder *via* a new route, by reaction of WSCl_4 ,¹⁹ $\text{S}(\text{SiMe}_3)_2$ and $[\text{PPh}_4]\text{Cl}$ in CH_2Cl_2 . $[\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ was obtained similarly as a brown powder using $[\text{NEt}_4]\text{Cl}$, but the corresponding $[\text{N}^i\text{Bu}_4]_2[\text{WS}_2\text{Cl}_4]$ formed as a sticky solid that was less convenient to handle, hence subsequent studies focussed on the $[\text{PPh}_4]^+$ and $[\text{NEt}_4]^+$ salts. The X-ray structure of $[\text{PPh}_4]_2[\text{WS}_2\text{Cl}_4]$ shows a *cis* octahedral anion with disordered S/Cl groups.¹⁸ The IR spectrum of the new $[\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ salt (Fig. S2 ESI[†]) contains a strong band at 498 cm^{-1} assigned as $\nu(\text{W}=\text{S})$, but a cation absorption obscures this region in the spectrum of $[\text{PPh}_4]_2[\text{WS}_2\text{Cl}_4]$. In $[\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ the $\nu(\text{W}-\text{Cl})$ region consists of a strong band at 289 cm^{-1} , along with weaker features at 321 and 230 cm^{-1} (theory $C_{2v} = 2A_1 + B_1 + B_2$).

In this work we use dichloromethane as the solvent for the electrochemical experiments because it is relatively inert, much less viscous than ionic liquids, and is only weakly coordinating, simplifying the solution speciation.²⁰

The electrochemical behaviour of $[\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ in CH_2Cl_2 was initially studied by performing cyclic voltammetry (CV) experiments. On the initial reduction scan using a TiN electrode, the voltammetry of $[\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ in dry CH_2Cl_2 shows that reduction starts at about -0.7 V with a shoulder around -1.3 V (Fig. 1). In comparison, the background voltammetry is featureless over this range, indicating that the relatively large reduction current corresponds to the reduction of the $[\text{WS}_2\text{Cl}_4]^{2-}$ ions. On the return scan, the reduction current is lower, with a shoulder at -1.15 V and then oxidation starts at $+0.5\text{ V}$, presumably due to oxidation of the deposited film.

To investigate the reduction of $[\text{WS}_2\text{Cl}_4]^{2-}$ we used the electrochemical quartz crystal microbalance (EQCM) technique. The voltammetry on the Pt EQCM electrode (Fig. 2a) shows essentially similar features, although these are now somewhat distorted by IR drop at the much larger electrode and show

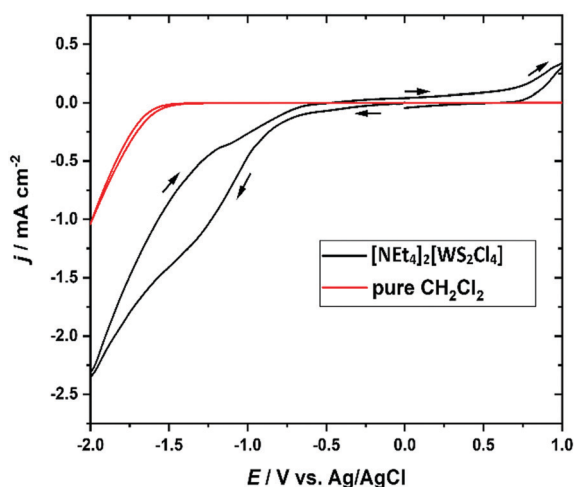


Fig. 1 Cyclic voltammogram of $5\text{ mM } [\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ in CH_2Cl_2 on a TiN electrode. The red line shows the background CV for CH_2Cl_2 . The supporting electrolyte is $0.1\text{ M } [\text{N}^i\text{Bu}_4]\text{Cl}$ and the scan rate is 50 mV s^{-1} . Arrows indicate the direction of potential scanning and the starting potential is 0 V .

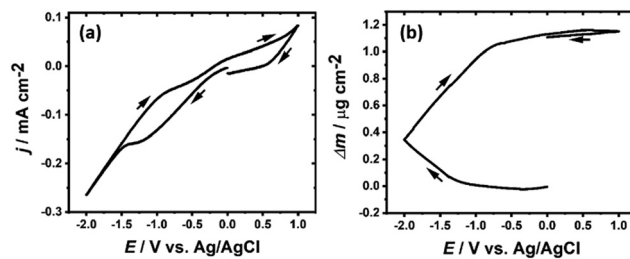


Fig. 2 (a) CV of $5\text{ mM } [\text{NEt}_4]_2[\text{WS}_2\text{Cl}_4]$ in CH_2Cl_2 on Pt coated quartz electrode. (b) The corresponding mass changes during the CV. The supporting electrolyte is $0.1\text{ M } [\text{N}^i\text{Bu}_4]\text{Cl}$ and the scan rate is 50 mV s^{-1} .

more significant oxidation at positive potentials, which is attributed to reaction of Cl^- on the Pt electrode. Following the mass changes on the EQCM shows that the reduction of the $[\text{WS}_2\text{Cl}_4]^{2-}$ is associated with an increase in mass starting from -1.2 V , which continues as the reduction potential increases to -2.0 V and then on the return scan to -0.7 V (Fig. 2b). This mass increase is coincident with the reduction wave observed in the CV and consistent with deposition of WS_2 . The possible electrochemical reduction reaction at the cathode is,



This is further confirmed by performing a potentiostatic deposition on the EQCM by polarising the working electrode at -1.3 V and recording the frequency change, which showed an approximately linear increase of mass with time (Fig. S6 ESI[†]). The reduction potentials of $[\text{WS}_2\text{Cl}_4]^{2-}$ are well removed from the cathodic breakdown of the solvent and therefore has higher faradaic efficiency ($\sim 25\%$) compared to MoS_2 electrodeposition in CH_2Cl_2 . Note that the current efficiency for MoS_2 electrodeposition was $< 10\%$ because the majority of the charge passed was used for the cathodic decomposition of Me_3NHCl and the consequent H_2 evolution at the cathode.⁹

To confirm the deposition of WS_2 , potentiostatic electrodeposition was carried out onto a TiN substrate for 1 h at -1.3 V . The as-deposited thin film was shown to be amorphous *via* X-ray diffraction and was annealed in a tube furnace at $100\text{ }^\circ\text{C}$ for 10 min followed by $500\text{ }^\circ\text{C}$ for 2 h under N_2 in a sulfur atmosphere. X-Ray diffraction of the annealed sample confirms the presence of crystalline WS_2 (Fig. 3). Scanning electron microscope (SEM) images of the annealed WS_2 deposit show a continuous and reasonably flat film with some cracks (Fig. 4a). The applied potential is found to have an effect on the roughness of the films as a thin film obtained at higher negative potential of -1.7 V shows a smoother deposit with a thickness of around 30 nm and roughness of 2.5 nm measured by AFM (Fig. S8, ESI[†]). Energy dispersive X-ray (EDX) analysis of the deposit shows signals at 1.75 keV , indicating the presence of W and/or Si and at 2.3 keV showing the presence of S (Fig. 4b). Signals for Si, Ti and N from the electrode substrate are also visible. The small oxygen signal detected in the films could be due either to the surface oxidation of the film by atmospheric oxygen or to the diffusion of O_2 into the film upon



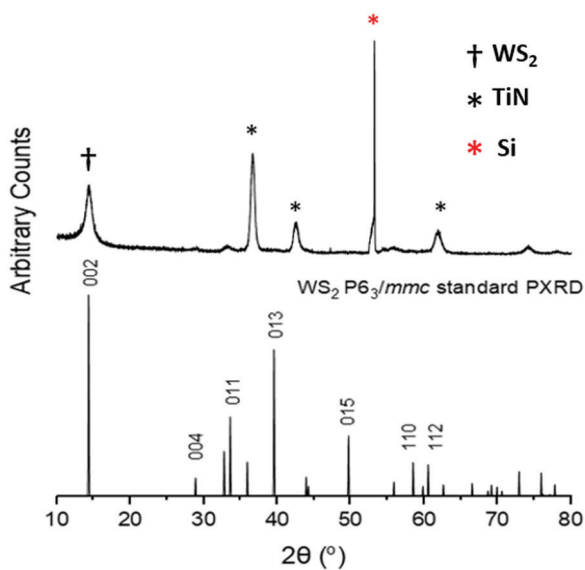


Fig. 3 Grazing incidence XRD pattern (top) from WS_2 electrodeposited from $[\text{NET}_4]_2[\text{WS}_2\text{Cl}_4]$ in CH_2Cl_2 . XRD pattern for bulk WS_2 (bottom).¹

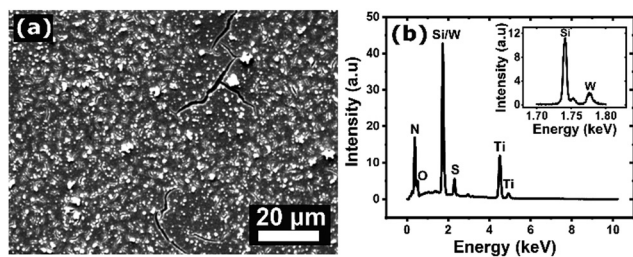


Fig. 4 (a) Top-view SEM image of the annealed deposit obtained after potentiostatic deposition at -1.3 V for 60 minutes from CH_2Cl_2 containing 5 mM $[\text{NET}_4]_2[\text{WS}_2\text{Cl}_4]$ with 0.1 M $[\text{N}^+\text{Bu}_4]\text{Cl}$ supporting electrolyte. (b) EDX profile of the deposited film after annealing. The inset shows WDX spectrum for Si and W.

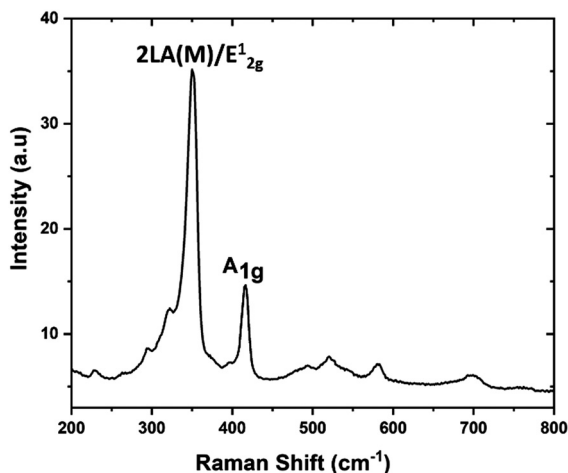


Fig. 5 Raman spectrum recorded from annealed WS_2 deposit using 532 nm laser excitation.

handling in ambient atmosphere. In the EDX spectrum, the Si- K_α (1.74 keV) and W- M_α (1.77 keV) peaks appear overlapped due to the low spectral resolution of the technique and so in order to confirm the presence of W and to determine the elemental composition, we used wavelength dispersive X-ray (WDX) spectroscopy to resolve these two peaks (Fig. 4b inset). Together, the EDX and WDX spectra confirm that the deposit contains both W and S with no significant impurities. The elemental composition obtained from the EDX/WDX spectra of both the as-deposited and annealed films show the W:S ratio is 1:2. This is further confirmed by XPS measurements (Fig. S9, ESI[†]).

The Raman spectrum of the annealed deposit at 532 nm laser excitation shows the two main peaks at 352 and 419 cm^{-1} , assigned to the $2\text{LA}(\text{M})/\text{E}_{2g}^1$ and A_{1g} vibrational modes of WS_2 , respectively (Fig. 5). The weaker features present in the Raman spectra are also consistent with literature data for WS_2 .²¹

In conclusion, electrodeposition of WS_2 using the customised $[\text{WS}_2\text{Cl}_4]^{2-}$ precursor is achieved *via* a relatively simple process that occurs without the need to add a proton source to the solution to remove excess S. The electrochemical reduction mechanism of $[\text{WS}_2\text{Cl}_4]^{2-}$ studied by the EQCM technique showed that the faradaic efficiency of the process is higher compared to MoS_2 electrodeposition in CH_2Cl_2 with an added proton source. The as-deposited WS_2 films are amorphous but can be crystallised by annealing at 500 $^\circ\text{C}$ under N_2 . The compositional and structural quality of the films were confirmed by XRD, SEM and Raman analysis, showing that electrodeposition from $[\text{WS}_2\text{Cl}_4]^{2-}$ allows deposition of films with good homogeneity and good reproducibility in composition. This provides a simple, scalable and low-cost method for WS_2 thin film deposition. This room temperature process also paves the way for future work on TMDC growth onto flexible substrates.

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Conflicts of interest

There are no conflicts to declare.

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